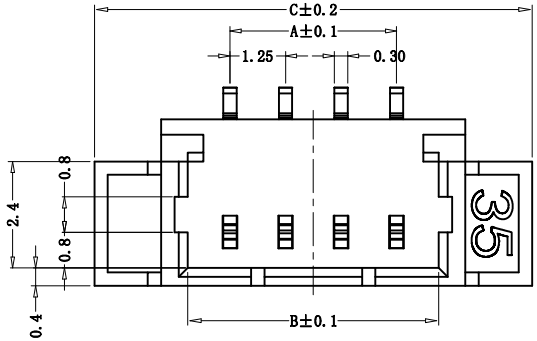
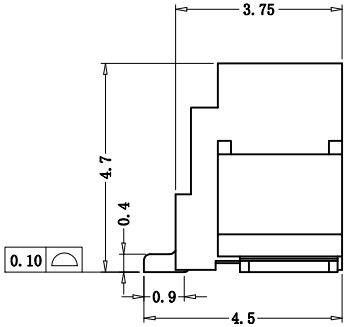
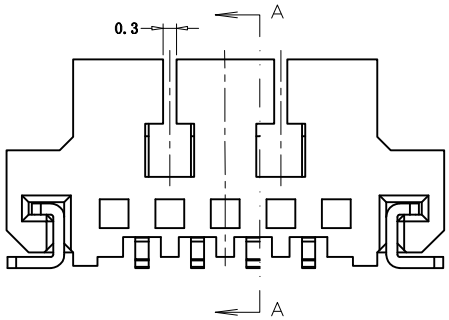
RoHS

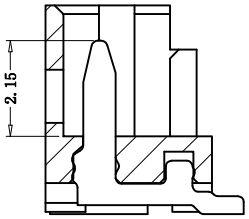
REV.	ECN NO.	LOCAS.	DESCRIPTION	DATE	DESIGN
A			NEW DRAWING		

孔位	A	B	C
2	1.25	3.10	7.35
3	2.50	4.35	8.60
7	7.50	9.35	13.60
8	8.75	10.60	14.85
9	10.00	11.85	16.10
10	11.25	13.10	17.35
11	12.50	14.35	18.60
12	13.75	15.60	19.85
13	15.00	16.85	21.10
14	16.25	18.10	22.35
15	17.50	19.35	23.60
16	18.75	20.60	24.85
17	20.00	21.85	26.10
18	21.25	23.10	27.35
19	22.50	24.35	28.60
20	23.75	25.60	29.85

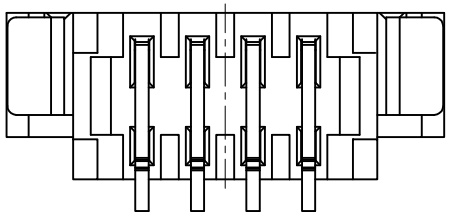


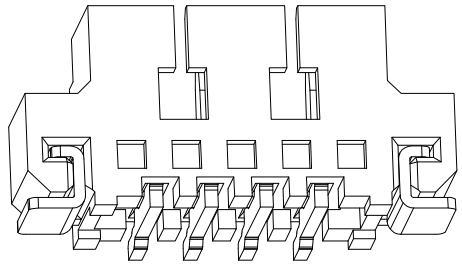


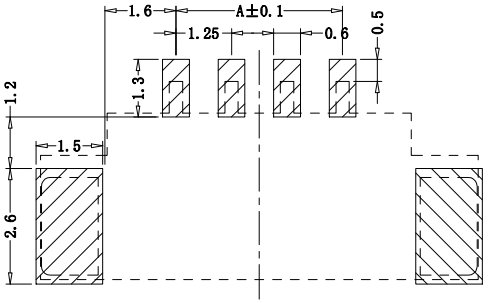




SECTION A—A







PC BOARD LAYOUT

技术要求(Technical Index):

1. 材质与表面处理(Material And Finish):
   基座（Housing）：LCP UL94V-0 Nature Or Black;
   端子（Terminal）:Phosphor Copper Au/Sn Plated;
   焊片（Solder）：Copper Alloy Au/Sn Plated;
2. 工作温度(Temperature range)：-20° C～+85° C.
3. 额定电压(Rated voltage)：100V，AC/DC.
4. 额定电流：1A,AC/DC.
5. 接触电阻(Contact resistance)：≤20mΩ.
6. 绝缘电阻(Insulation resistance):≥500MΩ.
7. 耐电压(Withstanding Voltage):500V AC/minute.

DESIGN:	Xiping Huang			广东国连电子有限公司 GUANGDONG GUOLIAN ELECTRONICS CO.,LTD	
CHECK:	Ke Tian				
APPROVED:	Youquan Xu				
DIM	TOL	DIM	TOL	TITLE:	1.25mm 条形连接器立贴开口
X.	±0.25				
X.X	±0.20	X° .	±3.0°	PART NO.	1.25-C-nPB-***
X.XX	±0.15	X.X°			
X.XXX		X.XX°		REV. A	SCALE: N/A / UNIT: mm / SHEET: 1/1
		X.XXX°			